MN101C77 Series

Туре	MN101C77A	MN101C77C	MN101C77D	MN101C77F	MN101CF77G			
Internal ROM type		FLASH						
ROM (byte)	32K	48K	64K	96K	128K			
RAM (byte)	1.5K	3K	6K					
Package (Lead-free)	LQFP064-P-1414	LQFP064-P-1414, TQFP064-P-1010C	LQFP064-P-1414		LQFP064-P-1414, TQFP064-P-1010C			
Minimum Instruction Execution Time	[Standard] 0.1 µs (at 2.5 V to 3.6 V, 20 MHz)* 0.2 µs (at 2.1 V to 3.6 V, 10 MHz)* 0.5 µs (at 1.8 V to 3.6 V, 4 MHz)* 62.5 µs (at 1.8 V to 3.6 V, 32 kHz)* [Double speed] 0.119 µs (at 2.5 V to 3.6 V, 8.39 MHz)* *: The operation guarantee range for flash memory built-in type is 2.7 V to 3.6 V.							

■ Interrupts

RESET. Watchdog. External 0 to 4. Timer 0. Timer 1. Timer 4 to 6. Timer 7 (2 systems). Time base. Serial 0 reception. Serial 0 transmission. Serial 3. Serial 4. Automatic transfer finish. A/D conversion finish. Key interrupts (8 lines)

Timer Counter

8-bit timer \times 5

Timer 0Square-wave/8-bit PWM output. Event count. Remote control carrier output. Pulse width measurement

Timer 1Square-wave output. Event count. Synchronous output event

Timer 4Square-wave/8-bit PWM output. Event count. Pulse width measurement. Serial 1 baud rate timer

Timer 5Square-wave/8-bit PWM output. Event count. Pulse width measurement. Serial 0 baud rate timer

Timer 68-bit freerun timer

Timer 0, 1 can be cascade-connected

16-bit timer \times 1

Timer 7Square-wave/16-bit PWM output (cycle/duty continuous variable). Event count. Synchronous output event. Pulse width measurement. Input capture

Time base timer: One-minute count setting Watchdog timer $\times 1$

Serial interface

Synchronous type/UART (full-duplex) \times 2: Serial 0, 1 Synchronous type/Single-master I²C \times 1: Serial 3 I²C slave \times 1: Serial 4

Serial 4.....I²C high-speed transfer mode. 7-bit/10-bit address setting. General call

DMA controller

Maximum transfer cycles: 255 Starting factor: External request. Various types of interrupt. Software Transfer mode: 1-byte transfer. Word transfer. Burst transfer

■ I/O Pins I/O

53 : Common use. Specified pull-up resistor available. Input/output selectable (bit unit)

A/D converter

10-bit \times 7 channels (with S/H)

D/A converter

8-bit \times 2 channels (Serves as AD pin, as well)

Special Ports

Buzzer output. Remote control carrier output. High-current drive port

ROM Correction

Correcting address designation: Up to 3 addresses possible

MN101C77A, MN101C77C, MN101C77D, MN101C77F, MN101CF77G

Parameter	Symbol	Condition	Limit			Unit			
Falameter		Condition		typ	max	Unit			
Operating supply current	IDD1	fosc = 20 MHz (fs = fosc/2). VDD = 3.3 V		6	12	mA			
	IDD2	fosc = 8.39 MHz (fs = fosc/2). VDD = 3.3 V		3	6	mA			
	IDD3	fx = 32.768 kHz (fs = fx/2). VDD = 3.3 V			40	μΑ			
Supply current at HALT	IDD4	fx = 32.768 kHz. VDD = 3.3 V. Ta = 25 °C		5	10	μΑ			
	IDD5	fx = 32.768 kHz. VDD = 3.3 V			40	μΑ			
Supply current at STOP	IDD6	VDD = 3.3 V. Ta = 25 °C			2	μΑ			
	IDD7	VDD = 3.3 V. Ta = 85 °C			30	μΑ			
Ta = -40 °C to +85 °C. VDD = 1.8 V to 3.6 V. VSS = 0 V									

Electrical Charactreistics (Supply current)

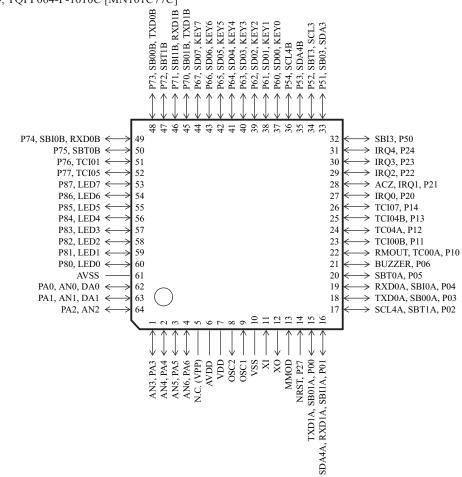
Development tools

In-circuit Emulator

PX-ICE101C/D + PX-PRB101C77-TQFP064-P-1010C PX-ICE101C/D + PX-PRB101C77-LQFP064-P-1414

Pin Assignment

LQFP064-P-1414, TQFP064-P-1010C [MN101C77C]



Note) Pin 5 serves as the VPP pin in the MN101CF77G, and cannot be used as a user pin.

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